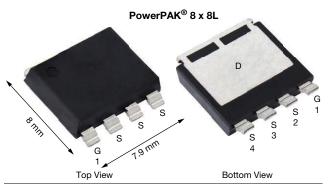
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**Vishay Siliconix** 

## N-Channel 150 V (D-S) 175 °C MOSFET



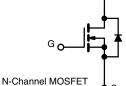
PRODUCT SUMMARY							
V <sub>DS</sub> (V)	150						
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0041						
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 7.5 V	0.0044						
Q <sub>g</sub> typ. (nC)	93						
I <sub>D</sub> (A) <sup>a</sup>	174						
Configuration	Single						

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen V power MOSFET
- Fully lead (Pb)-free device
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure of merit (FOM)
- Up to 174 A maximum continuous drain current
- 50 % smaller footprint than D<sup>2</sup>PAK (TO-263)
- 100 %  $R_{\alpha}$  and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Synchronous rectification
- OR-ing
- Motor drive control
- Battery management



D

ORDERING INFORMATION	
Package	PowerPAK 8 x 8L
Lead (Pb)-free and halogen-free	SIJH5700E-T1-GE3

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	150	V	
Gate-source voltage		V <sub>GS</sub>	±20		
	T <sub>C</sub> = 25 °C		174		
	T <sub>C</sub> = 70 °C		138		
Continuous drain current (T <sub>J</sub> = 175 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	17 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		15 <sup>b</sup>	Α	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	500		
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		303		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3 b		
Single pulse avalanche current		I <sub>AS</sub>	40		
Single pulse avalanche energy L = 0.1 mH		E <sub>AS</sub>	80	mJ	
	T <sub>C</sub> = 25 °C		333		
Maximum power dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	233	w	
Maximum power dissipation	T <sub>A</sub> = 25 °C	FD	3.3 <sup>b</sup>	vv	
	T <sub>A</sub> =70 °C	1	2.3 <sup>b</sup>		
Operating junction and storage temperature	e range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak tempera		260			

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b	Steady state	R <sub>thJA</sub>	36	45	°C/W		
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.36	0.45	0/10		

Notes

a.  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board
c. See solder profile (www.vishay.com/doc?73257). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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SiJH5700E Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 1 mA$	150	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	86	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-9.5	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	-	4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20$	-	-	100	nA
Zara gata valtaga drain aurrant	1	$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	$V_{DS}$ = 120 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C	-	-	15	μA
Drain actures on state registeres à	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0034	0.0041	Ω
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0036	0.0044	52
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 70 \text{ A}$	-	175	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	7500	-	
Output capacitance	C <sub>oss</sub>	$V_{DS}$ = 75 V, $V_{GS}$ = 0 V, f = 1 MHz	-	620	-	pF
Reverse transfer capacitance	verse transfer capacitance C <sub>rss</sub>		-	12	-	
Total gata obarga	0	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	93	140	
Total gate charge	Qg		-	70	105	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = 75 V, $V_{GS}$ = 7.5 V, $I_{D}$ = 20 A	-	36	-	nC
Gate-drain charge	Q <sub>gd</sub>	- 8		8	-	
Gate resistance	stance R <sub>g</sub> f = 1 MHz		0.36	1.8	3.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	28	60	
Rise time	tr	$V_{DD}$ = 75 V, $R_L$ = 7.5 $\Omega$ , $I_D \cong$ 10 A,	-	20	40	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	-	45	90	
Fall time	t <sub>f</sub>		-	45	90	-
Turn-on delay time	t <sub>d(on)</sub>		-	24	50	ns
Rise time	t <sub>r</sub>	$V_{DD} = 75 \text{ V}, \text{ R}_{L} = 7.5 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	33	70	-
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = 7.5 V, $R_g$ = 1 $\Omega$	-	41	80	
Fall time	t <sub>f</sub>		-	46	90	
<b>Drain-Source Body Diode Characteris</b>	tics					
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	303	A
Pulse diode forward current	I <sub>SM</sub>		-	-	500	А
Body diode voltage	V <sub>SD</sub>	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.75	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	197	400	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	L = 10.0  dt/dt = 100.0 / up T = 05.00	-	1480	2960	nC
Reverse recovery fall time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	-	141	-	20
Reverse recovery rise time	t <sub>b</sub>		-	56	-	ns

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

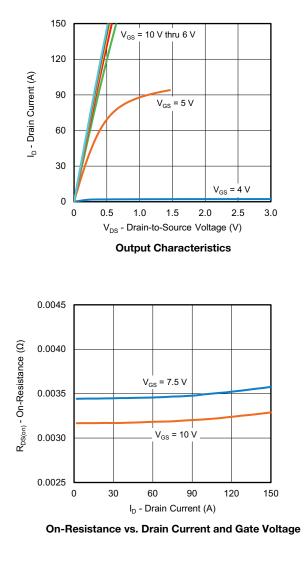
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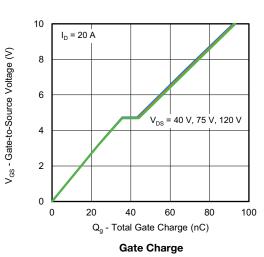
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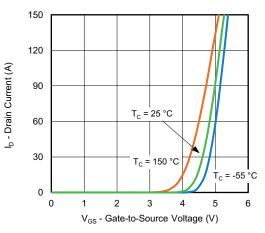


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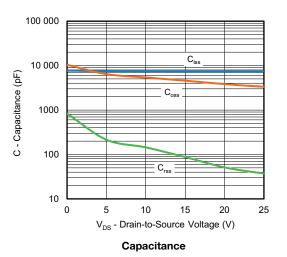
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

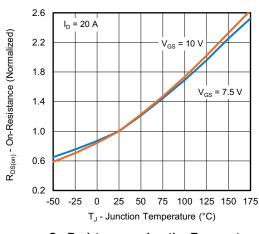






**Transfer Characteristics** 





**On-Resistance vs. Junction Temperature** 

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3

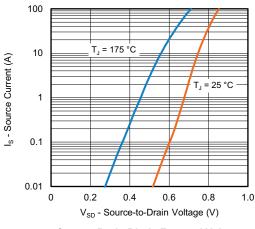
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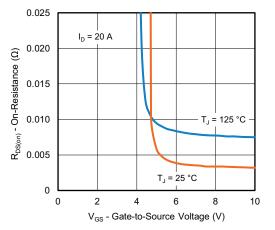


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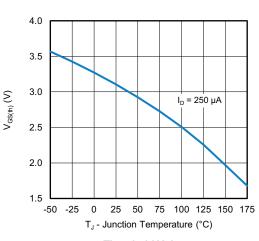
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



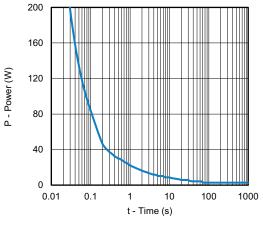
Source-Drain Diode Forward Voltage



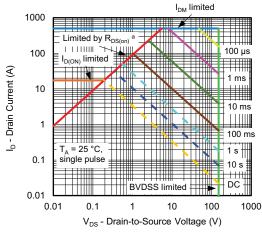
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

#### Note

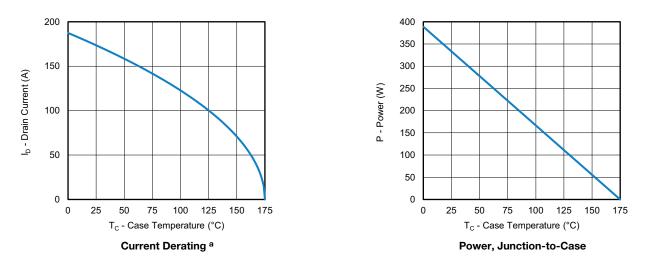
a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



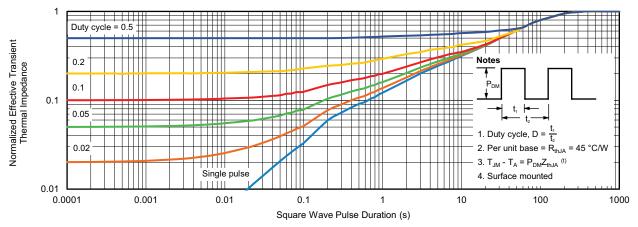
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

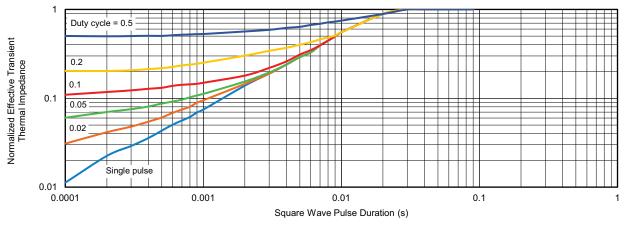


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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

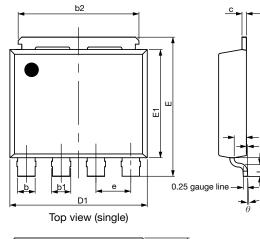
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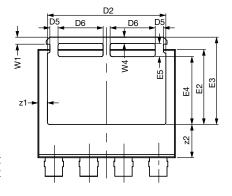
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# PowerPAK<sup>®</sup> 8 x 8L BWL Case Outline 2

A1





Bottom view (single)

1						_ <b>↑</b>
F	-		-	-	A.	<
l	_					

DIM.		MILLIMETERS			INCHES	
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	1.50	1.60	1.70	0.059	0.063	0.067
A1	0.00	-	0.127	0.000	-	0.005
A2	0.655	0.705	0.755	0.026	0.028	0.030
b	0.92	1.00	1.08	0.036	0.039	0.043
b1	1.02	1.10	1.18	0.040	0.043	0.046
b2	6.84	6.94	7.04	0.269	0.273	0.277
С	0.20	0.25	0.30	0.008	0.010	0.012
D1	7.80	7.90	8.00	0.307	0.311	0.315
D2	6.70	6.80	6.90	0.264	0.268	0.272
D5	0.37	0.47	0.57	0.015	0.019	0.022
D6	2.49	2.59	2.69	0.098	0.102	0.106
е	1.97	2.00	2.03	0.078	0.079	0.080
Е	7.90	8.00	8.10	0.311	0.315	0.319
E1	6.12	6.22	6.32	0.241	0.245	0.249
E2	4.21	4.31	4.41	0.166	0.170	0.174
E3	4.92	5.02	5.12	0.194	0.198	0.202
E4	3.80	3.90	4.00	0.150	0.154	0.157
E5	0.65	0.75	0.85	0.026	0.030	0.033
L	0.61	0.68	0.75	0.024	0.027	0.030
L1	1.00	1.07	1.15	0.039	0.042	0.045
W1	0.30	0.40	0.50	0.012	0.016	0.020
W4	0.32	0.37	0.42	0.013	0.015	0.017
z1	0.45	0.55	0.65	0.018	0.022	0.026
z2	1.81	1.91	2.01	0.071	0.075	0.079
θ	0°	-	5°	0°	-	5°
N: S19-0643-F G: 6073	lev. B, 05-Aug-2019					

#### Note

• Millimeter will govern

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